

HSF

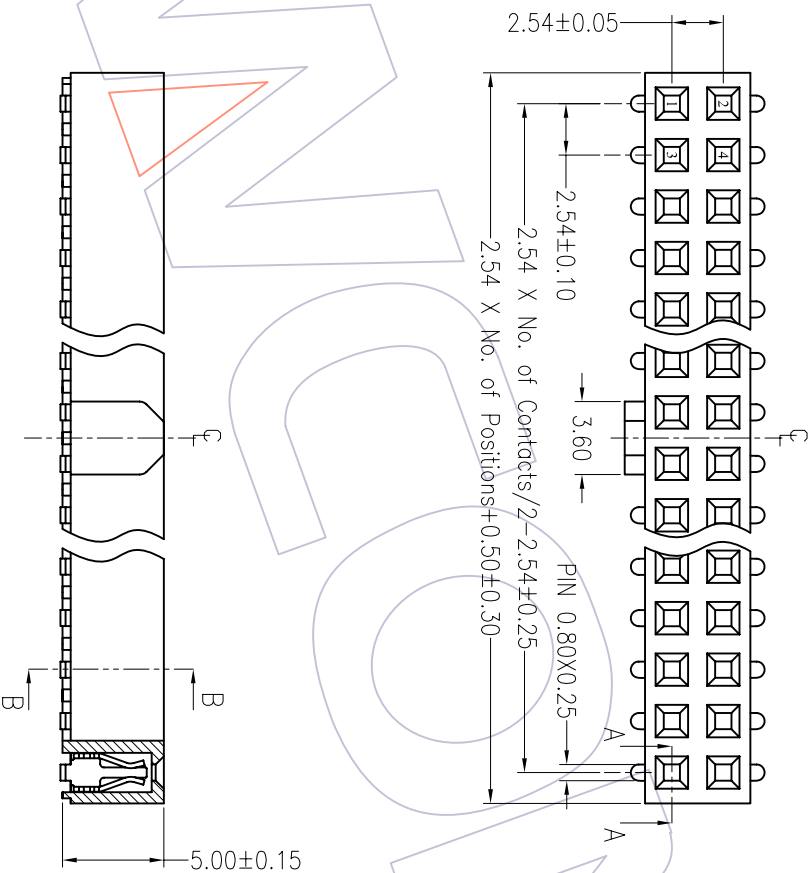
NOTES:

Current Rating:3.0AMP
 Contact Resistance:20mΩ max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ min
 Operation Temperature:-40°C. to +105°C
 Contact Material:Phosphor Bronze
 Contact plating:Au or Sn Over Ni
 Insulator Material:PA6T+30%G.F UL94V-0

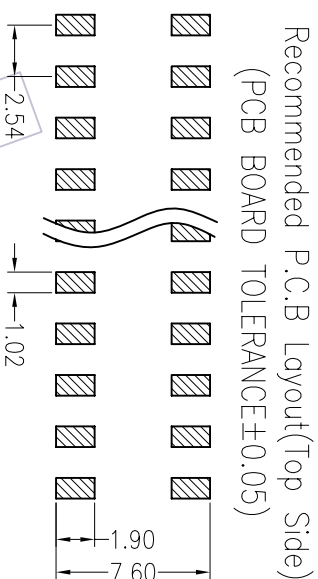
Ordering Information

2150 - 2 XXX M XX CUN T3

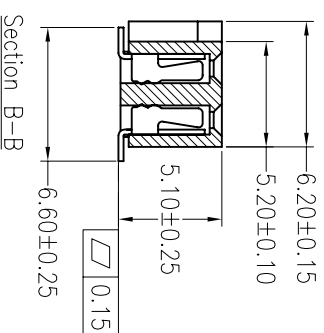
No. of Pins per Row: 01-40
 Contact Plating
 G0=Gold Flash
 G1 =5u"Gold
 G2=5u"Gold
 G3=10u"Gold
 G4=15u"Gold
 G5=30u"Gold
 S0=Gold Flash/Tin
 S1=3u"Gold/Tin
 S2=5u"Gold/Tin
 S3=10u"Gold/Tin
 S4=15u"Gold/Tin
 S5=30u"Gold/Tin
 SN=Tin



Section A-A



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Section B-B

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW		SCALE		PART NO.	TITLE:
					XXX	±0.40	William	08/06/12	1:1	WCON		
A0	08/06/12	NEW			XXX	±0.25	DESIGN		UNIT	mm	2150-2XXXXCUNT3	PH2.54 DUAL SMT H=5.0 WITH BUMP
					X.XXX	±0.15	CHECK	SIZE	A4			
					Angle	± 3'	APPROVE	SHEET	1/1			
					DIM	TOL		PROJ.			Customer NO.	

WCON 维峰五金电子有限公司
 WAFER HARDWARE ELECTRONICS CO., LTD